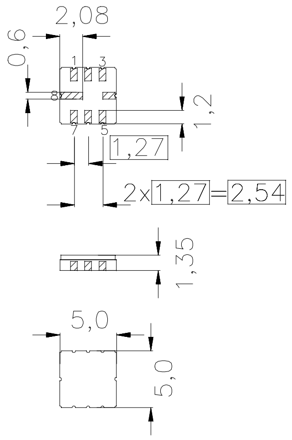
SAW Components

Data Sheet B3572

Ceramic package **QCC8C**



typ. dimensions in mm, approx. weight 0,1 g

Features

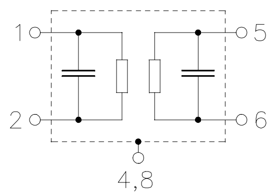
- RF low-loss filter for remote control receivers
- Package for **S**urface **M**ounted **T**echnology (**SMT**)

Terminals

- Ni, gold plated

Pin configuration

1	Input
2,7	Input Ground
5	Output
3,6	Output Ground
4,8	Case - Ground



Type	Ordering code	Marking and package according to	Packing according to
B3572	B39871-B3572-U310	C61157-A7-A56	F61074-V8070-Z000

Electrostactic **S**ensitive **D**evice (**ESD**)

Maximum ratings

Operable temperature range	T_A	–45/+105	˚C	
Storage temperature range	T_{stg}	–45/+105	˚C	
DC voltage	V_{DC}	0	V	
Source power	P_S	0	dBm	source impedance 50 Ω

Characteristics

Reference temperature: T_A = 25 °C
Terminating source impedance: Z_S = 50 Ω and matching network
Terminating load impedance: Z_L = 50 Ω and matching network

		min.	typ.	max.	
Center frequency (center frequency between 3 dB points)	f_C	—	869,04	—	MHz
Minimum insertion attenuation	α_{min}				
868,70 ... 869,38 MHz		—	2,7	4,2	dB
Pass band (relative to α_{min})					
868,70 ... 869,38 MHz		—	1,0	3,0	dB
868,60 ... 869,48 MHz		—	1,5	6,0	dB
Relative attenuation (relative to α_{min})	α_{rel}				
10,00 ... 700,00 MHz		50	55	—	dB
700,00 ... 830,00 MHz		35	45	—	dB
830,00 ... 850,60 MHz		32	40	—	dB
850,60 ... 865,80 MHz		25	30	—	dB
871,60 ... 875,10 MHz		11	16	—	dB
875,10 ... 883,60 MHz		22	27	—	dB
883,60 ... 900,00 MHz		30	35	—	dB
900,00 ...1000,00 MHz		35	40	—	dB
Impedance for pass band matching					
Input: $Z_{IN} = R_{IN} \parallel C_{IN}$		—	200 ∥ 2,40	—	Ω ∥ pF
Output: $Z_{OUT} = R_{OUT} \parallel C_{OUT}$		—	200 ∥ 2,40	—	Ω ∥ pF
Temperature coefficient of frequency 1)	TC_f	—	–0,03	—	ppm/K^2
Frequency inversion point	T_0	15	—	35	°C

1) Temperature dependence of f_C: $f_C(T_A) = f_C(T_0)\,(1 + TC_f(T_A - T_0)^2)$

Characteristics

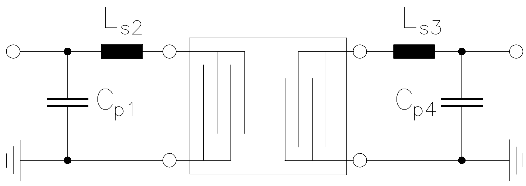
Reference temperature: T_A = –45 ... 90 ˚C
Terminating source impedance: Z_S = 50 Ω and matching network
Terminating load impedance: Z_L = 50 Ω and matching network

		min.	typ.	max.	
Center frequency (center frequency between 3 dB points)	f_C	—	868,95	—	MHz
Minimum insertion attenuation	α_{min}				
868,70 ... 869,20 MHz		—	2,7	4,7	dB
Pass band (relative to α_{min})					
868,70 ... 869,20 MHz		—	1,0	3,0	dB
868,60 ... 869,30 MHz		—	1,5	6,0	dB
Relative attenuation (relative to α_{min})	α_{rel}				
10,00 ... 700,00 MHz		50	55	—	dB
700,00 ... 830,00 MHz		35	45	—	dB
830,00 ... 850,60 MHz		32	40	—	dB
850,60 ... 865,62 MHz		25	30	—	dB
871,60 ... 875,10 MHz		11	16	—	dB
875,10 ... 883,60 MHz		22	27	—	dB
883,60 ... 900,00 MHz		30	35	—	dB
900,00 ...1000,00 MHz		35	40	—	dB
Impedance for pass band matching [2]					
Input: $Z_{IN} = R_{IN} \parallel C_{IN}$		—	200 ‖ 2,40	—	Ω ‖ pF
Output: $Z_{OUT} = R_{OUT} \parallel C_{OUT}$		—	200 ‖ 2,40	—	Ω ‖ pF

[2] Impedance for passband matching bases on an ideal, perfect matching of the SAW filter to source- and to load impedance (here 50 Ohm). After the SAW filter is removed and input impedance into the input matching / output matching network is calculated.

The conjugate complex value of these characteristic impedances are the input and output impedances for flat passband. For more details, we refer to EPCOS application note #4.

Matching network to 50 Ω (element values depend on pcb layout and equivalent circuit**)**



C_{p1} = 3,3 pF
L_{s2} = 12 nH
L_{s3} = 12 nH
C_{p4} = 3,3 pF

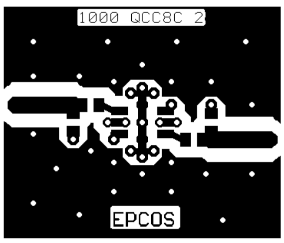
Minimising the crosstalk

For a good ultimate rejection a low crosstalk is necessary. Low crosstalk can be realised with a good RF layout. The major crosstalk mechanism is caused by the “ground-loop” problem.

Grounding loops are created if input-and output transducer GND are connected on the top-side of the PCB and fed to the system grounding plane by a common via hole. To avoid the common ground path, the ground pin of the input- and output transducer are fed to the system ground plane (bottom PCB plane) by their own via hole. The transducers’ grounding pins should be isolated from the upper grounding plane.

A common GND inductivity of 0.5nH degrades the ultimate rejection (crosstalk) by 20dB.

The optimised PCB layout, including matching network for transformation to 50 Ohm, is shown here. In this PCB layout the grounding loops are minimised to realise good ultimate rejection.

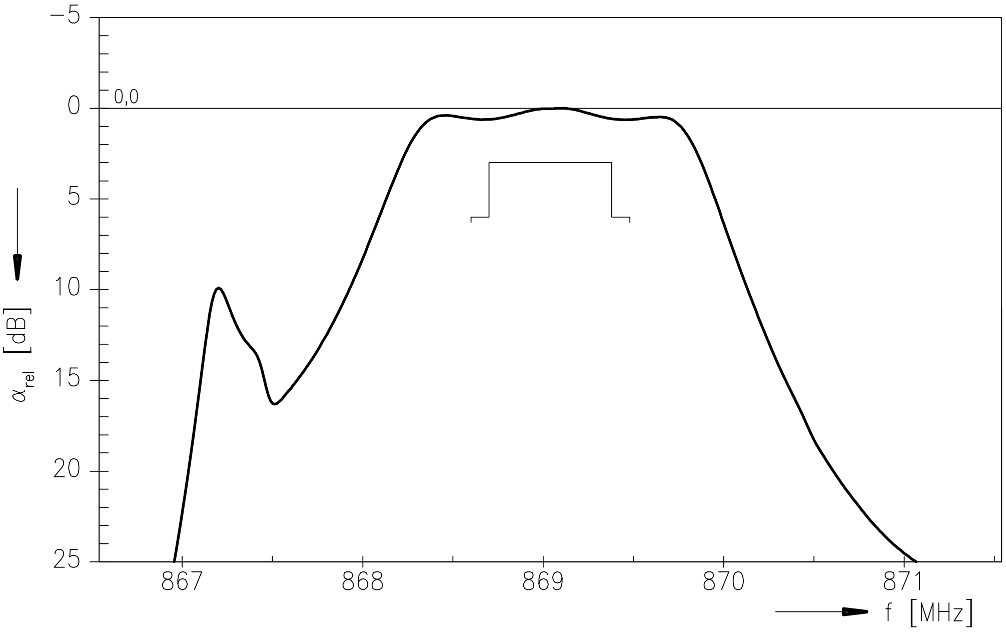


Optimised PCB layout for SAW filters in QCC8C package, pinning 1,5 (top side, scale 1:1)

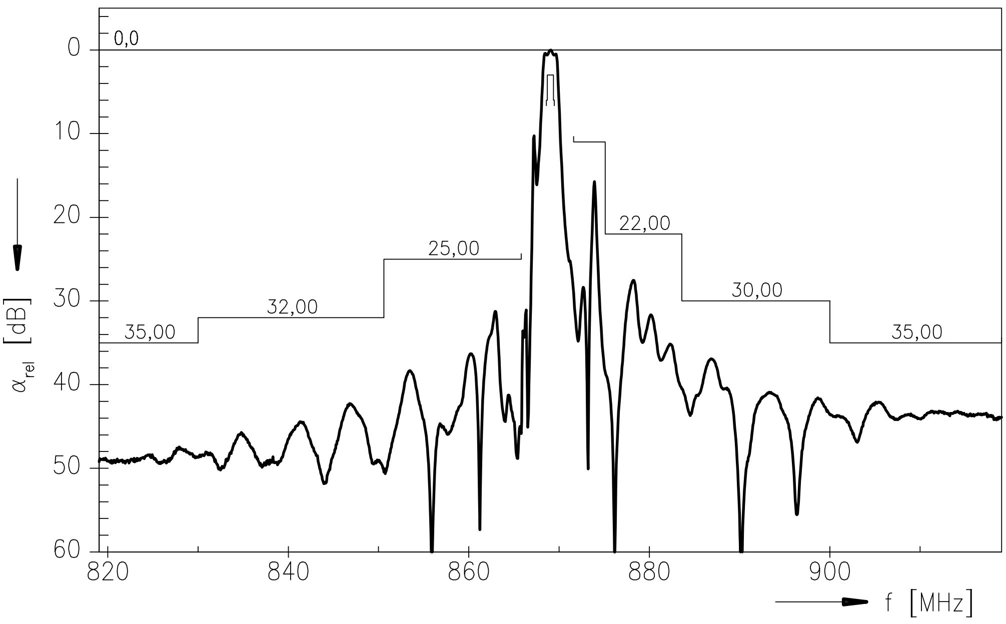
The bottom side is a copper plane (system ground area). The input and output grounding pins are isolated and connected to the common ground by separated via holes.

For good contact of the upper grounding area with the lower side it is necessary to place enough via holes.

Normalized frequency response



Normalized frequency response (wideband)



Published by EPCOS AG
Surface Acoustic Wave Components Division, SAW CE AE PD
P.O. Box 80 17 09, D-81617 München

© EPCOS AG 2004. All Rights Reserved. Reproduction, publication and dissemination of this brochure and the information contained therein without EPCOS' prior express consent is prohibited.

The information contained in this brochure describes the type of component and shall not be considered as guaranteed characteristics. Purchase orders are subject to the General Conditions for the Supply of Products and Services of the Electrical and Electronics Industry recommended by the ZVEI (German Electrical and Electronic Manufacturers' Association), unless otherwise agreed.

This brochure replaces the previous edition.

For questions on technology, prices and delivery please contact the Sales Offices of EPCOS AG or the international Representatives.

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our Sales Offices.